

## INTELLIGENT POWER HIGH SIDE SWITCH

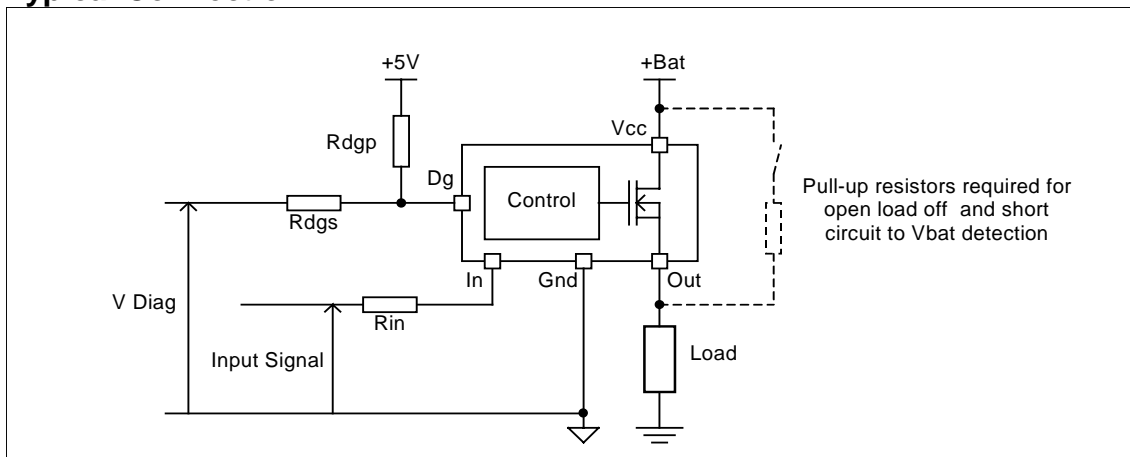
### Features

- Over temperature shutdown (with auto-restart)
- Short circuit protection (current limit)
- Reverse battery protection (turns On the MOSFET)
- Full diagnostic capability (short circuit to battery)
- Active clamp
- Open load detection in On and Off state
- Ground loss protection
- Logic ground isolated from power ground
- ESD protection

### Description

The IPS6044GPbF is quad output Intelligent Power Switch (IPS) for use in a high side configuration. It features short circuit, over-temperature, ESD protection, inductive load capability and diagnostic feedback. The output current is limited to the Ilim value. The current limitation is activated until the thermal protection acts. The over-temperature protection turns off the device if the junction temperature exceeds the Tshutdown value. It will automatically restart after the junction has cooled 7°C below the Tshutdown value. The reverse battery protection turns On the MOSFET. A diagnostic pin provides different voltage levels for each fault condition. The double level shifter circuitry will allow large offsets between the logic and load ground.

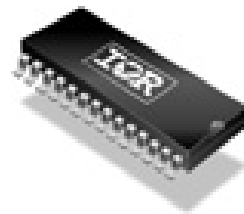
### Typical Connection



### Product Summary

R <sub>ds(on)</sub>	130mΩ max.
V <sub>clamp</sub>	39V
I <sub>Limit</sub>	7A
Open load	3V / 0.22A

### Package



SO28 Wide body

**Qualification Information<sup>†</sup>**

<b>Qualification Level</b>		Automotive (per AEC-Q100 <sup>††</sup> )	
		Comments: This family of ICs has passed an Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.	
<b>Moisture Sensitivity Level</b>		SOIC28W	MSL2, 260°C (per IPC/JEDEC J-STD-020)
<b>ESD</b>	Machine Model	Class B (per JEDEC standard JESD22-A115)	
	Human Body Model	Class 1C (per EIA/JEDEC standard EIA/JESD22-A114)	
<b>RoHS Compliant</b>		Yes	

<sup>†</sup> Qualification standards can be found at International Rectifier's web site <http://www.irf.com/>

<sup>††</sup> Exceptions to AEC-Q100 requirements are noted in the qualification report.

## Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are referenced to Ground lead. (Tambient=25°C unless otherwise specified).

Symbol	Parameter	Min.	Max.	Units
Vout	Maximum output voltage	Vcc-35	Vcc+0.3	V
Voffset	Maximum logic ground to load ground offset	Vcc-35	Vcc+0.3	
Vin	Maximum input voltage	-0.3	5.5	
Vcc max.	Maximum Vcc voltage	—	36	
Vcc cont.	Maximum continuous Vcc voltage	—	28	
Iin max.	Maximum IN current	-3	10	mA
I <sub>dg</sub> max.	Maximum diagnostic output current	-3	10	
V <sub>dg</sub>	Maximum diagnostic output voltage	-0.3	5.5	V
Pd	Maximum power dissipation (internally limited by thermal protection) R <sub>th</sub> =130°C/W per channel	—	3.8	W
ESD	Electrostatic discharge voltage (Human body) C=100pF, R=1500Ω Between In and Vcc	—	1500	V
	Other combinations	—	4000	
	Electrostatic discharge voltage (Machine Model) C=200pF, R=0Ω, L=10μH Between In and Vcc	—	100	
	Other combinations	—	500	
T <sub>j</sub> max.	Max. storage & operating temperature junction temperature	-40	150	°C
T <sub>soldering</sub>	Soldering temperature (10 seconds)	—	300	°C

## Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
R <sub>th1</sub>	Thermal resistance junction to ambient 1" sqrt. Footprint / 1 channel On	50	—	°C/W
R <sub>th2</sub>	Thermal resistance junction to ambient 1" sqrt. Footprint / 2 channels On	100	—	
R <sub>th3</sub>	Thermal resistance junction to ambient 1" sqrt. Footprint / 4 channels On	130	—	

note : T<sub>j</sub>=Power dissipated in one channel x R<sub>th</sub>

## Recommended Operating Conditions

These values are given for a quick design. For operation outside these conditions, please consult the application notes.

Symbol	Parameter	Min.	Max.	Units
V <sub>IH</sub>	High level input voltage	4	5.5	
V <sub>IL</sub>	Low level input voltage	0	0.9	
I <sub>out</sub>	Continuous drain current, R <sub>th</sub> =130°C/W, T <sub>j</sub> =150°C, 4 channels On T <sub>ambient</sub> =85°C / 1" sqrt. footprint T <sub>ambient</sub> =105°C / 1" sqrt. footprint	—	1.5 1.2	A
R <sub>in</sub>	Recommended resistor in series with IN pin	4	10	
R <sub>dgs</sub>	Recommended resistor in series with DG pin for reverse battery protection	4	20	kΩ
R <sub>dgp</sub>	Recommended pull-up resistor for DG	4	20	
R <sub>ol</sub>	Recommended pull-up resistor for open load detection	5	100	
F max.	Max. switching frequency	—	3.5	kHz

## Static Electrical Characteristics

T<sub>j</sub>=25°C, V<sub>cc</sub>=14V (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
R <sub>ds(on)</sub>	ON state resistance T <sub>j</sub> =25°C	—	110	130	mΩ	V <sub>in</sub> =5V, I <sub>out</sub> =2.5A
	ON state resistance T <sub>j</sub> =150°C(1)	—	190	230		V <sub>in</sub> =5V, I <sub>out</sub> =2.5A
	ON state resistance T <sub>j</sub> =25°C, V <sub>cc</sub> =6V	—	125	155		V <sub>in</sub> =5V, I <sub>out</sub> =1.5A
	ON state resistance during reverse battery	—	140	180		V <sub>cc</sub> -Gnd=14V
V <sub>cc op.</sub>	Operating voltage range	6	—	28	V	
V clamp 1	V <sub>cc</sub> to Out clamp voltage 1	37	39	—		I <sub>out</sub> =20mA
V clamp 2	V <sub>cc</sub> to Out clamp voltage 2	—	40	42		I <sub>out</sub> =2.5A (see Fig. 1)
I <sub>cc Off</sub>	Supply current when Off	—	4	9	μA	V <sub>in</sub> =0V, V <sub>out</sub> =0V
I <sub>cc On</sub>	Supply current when On	—	2.2	5	mA	V <sub>in</sub> =5V
V <sub>ih</sub>	Input high threshold voltage	—	2.5	2.9	V	
V <sub>il</sub>	Input low threshold voltage	1.5	2	—		
I <sub>n hyst.</sub>	Input hysteresis	0.2	0.5	1		
I <sub>in On</sub>	Input current when device is On	—	45	100	μA	V <sub>in</sub> =5V
I <sub>dg</sub>	Dg leakage current	—	0.1	10		V <sub>dg</sub> =5V
V <sub>dg</sub>	Low level DG voltage	—	0.25	0.4	V	I <sub>dg</sub> =1.6mA

## Switching Electrical Characteristics

V<sub>cc</sub>=14V, Resistive load=6Ω, V<sub>in</sub>=5V, T<sub>j</sub>=25°C

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
T <sub>don</sub>	Turn-on delay time	—	5	15	μs	see Fig. 3
Tr1	Rise time to V <sub>out</sub> =V <sub>cc</sub> -5V	—	3	10		
Tr2	Rise time to V <sub>out</sub> =0.9 x V <sub>cc</sub>	—	4	20		
dV/dt (On)	Turn On dV/dt	—	2.5	5	V/μs	
E <sub>On</sub>	Turn On energy	—	100	—	μJ	
T <sub>doff</sub>	Turn-off delay time	—	10	20	μs	
T <sub>f</sub>	Fall time to V <sub>out</sub> =0.1 x V <sub>cc</sub>	—	3	10		
dV/dt (Off)	Turn Off dV/dt	—	6.5	20	V/μs	
E <sub>Off</sub>	Turn Off energy	—	50	—	μJ	

## Protection Characteristics

T<sub>J</sub>=25°C, V<sub>CC</sub>=14V (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
I <sub>lim</sub>	Internal current limit	4	7	10	A	V <sub>out</sub> =0V
T <sub>sd+</sub>	Over temperature high threshold	150(1)	165	—	°C	See fig. 2
T <sub>sd-</sub>	Over temperature low threshold	—	158	—		
V <sub>sc</sub>	Short-circuit detection voltage(2)	2	3	4		
UV		—	5	5.9	V	
UV hyst.		0.25	—	1.6		
VOL Off	Open load detection threshold	2	3	4		
I <sub>OL</sub> On	Open load detection threshold	0.05	0.15	0.22	A	

(1) Guaranteed by design

(2) Reference to V<sub>CC</sub>

## True Table

Operating Conditions	IN	OUT	DG
Normal	H	H	H
Normal	L	L	H
Open Load	H	H	L
Open Load (3)	L	H	L
Short circuit to Gnd	H	L	L
Short circuit to Gnd	L	L	H
Short circuit to V <sub>CC</sub>	H	H	L (4)
Short circuit to V <sub>CC</sub> (5)	L	H	L
Over-temperature	H	L	L
Over-temperature	L	L	H

(3) With a pull-up resistor connected between the output and V<sub>CC</sub>.

(4) V<sub>ds</sub> lower than 10mV.

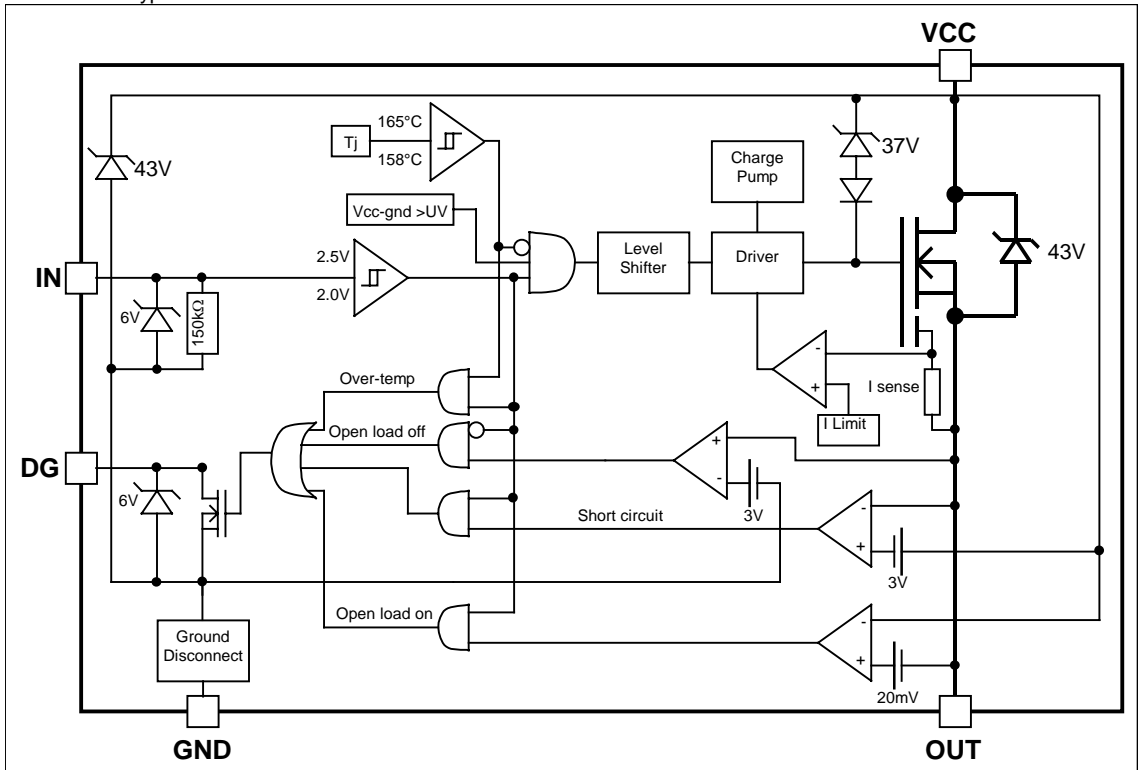
(5) Without a pull-up resistor connected between the output and V<sub>CC</sub>.

## Lead Assignments

1- Vcc	15- Vcc	
2- GND1	16- OUT4	
3- IN1	17- OUT4	
4- DG1	18- OUT4	
5- DG2	19- OUT3	
6- IN2	20- OUT3	
7- GND2	21- OUT3	
8- GND3	22- OUT2	
9- IN3	23- OUT2	
10- DG3	24- OUT2	
11- DG4	25- OUT1	
12- IN4	26- OUT1	
13- GND4	27- OUT1	
14- VCC	28- Vcc	

**Functional Block Diagram**

All values are typical



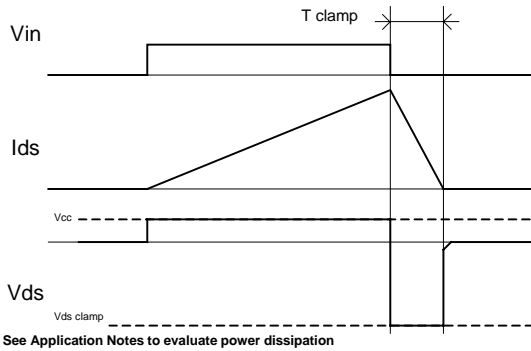


Figure 1 – Active clamp waveforms

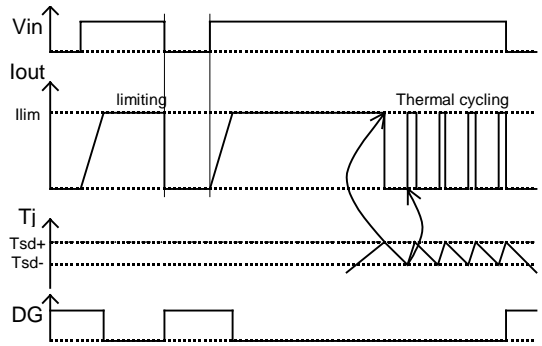


Figure 2 – Protection timing diagram

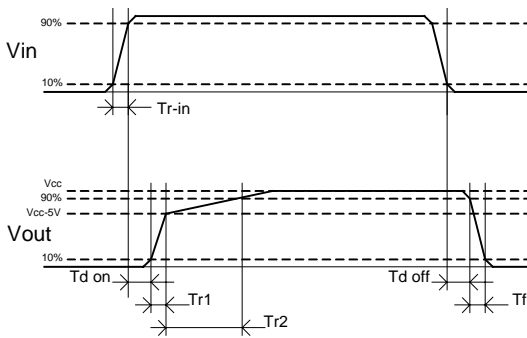


Figure 3 – Switching times definitions

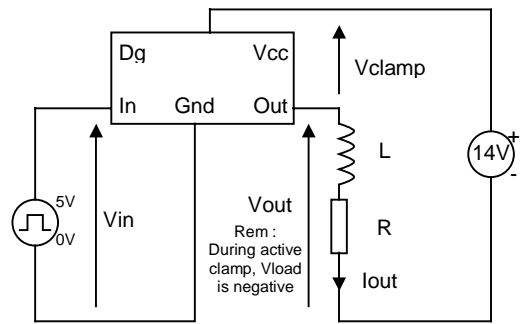
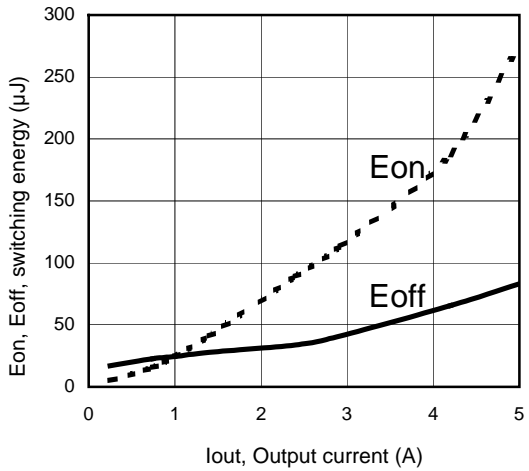
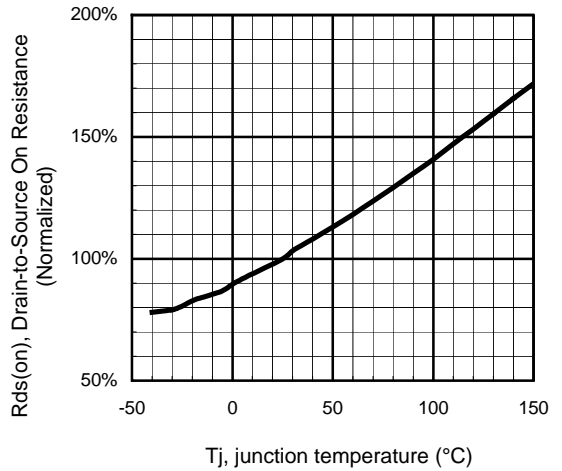


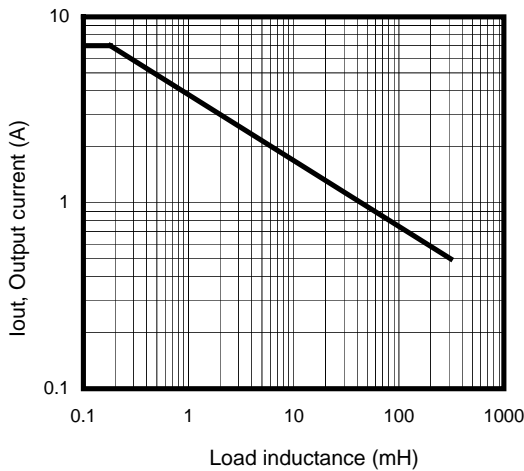
Figure 4 – Active clamp test circuit



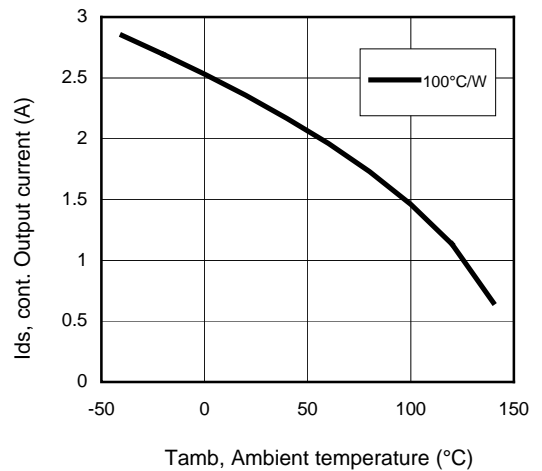
**Figure 5 – Switching energy (μJ) Vs Output current (A)**



**Figure 6 - Normalized R<sub>ds(on)</sub> (%) Vs T<sub>j</sub> (°C)**



**Figure 7 – Max. Output current (A) Vs Load inductance (mH)**



**Figure 8 – Max. output current (A) Vs Ambient temperature (°C)**



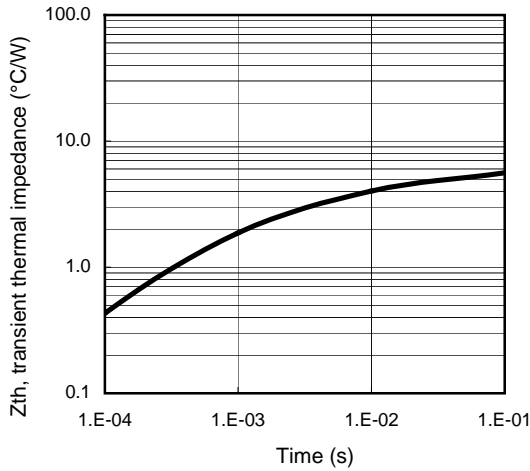


Figure 9 – Transient thermal impedance (°C/W) Vs time (s)

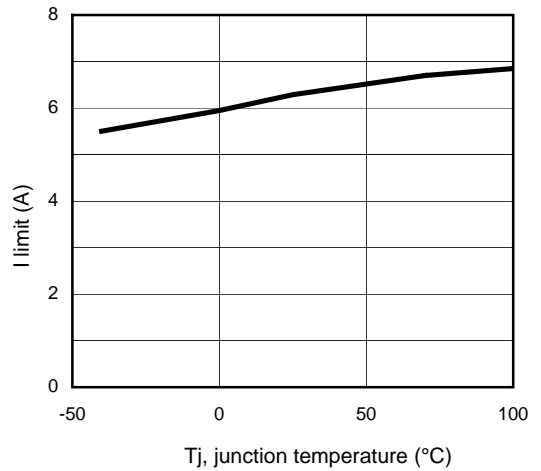


Figure 10 – I limit (A) Vs junction temperature (°C)

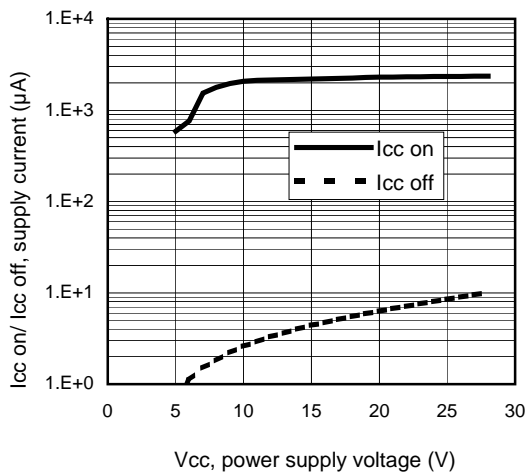


Figure 11 – Icc on/ Icc off (µA) Vs Vcc (V)

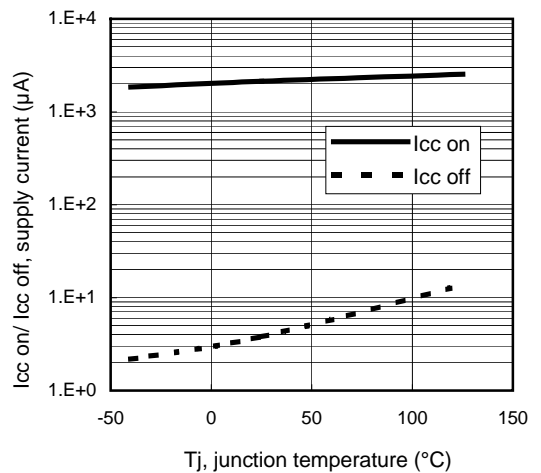
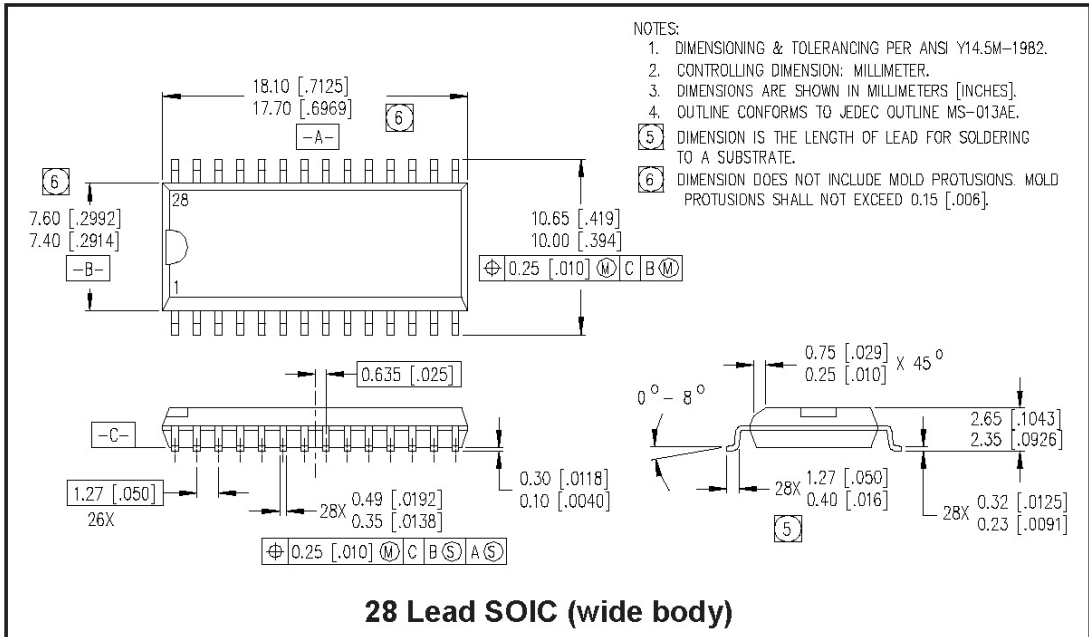


Figure 12 – Icc on/ Icc off (µA) Vs Tj (°C)

**Case Outline – SO28**



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**Revision History**

<b>Revision</b>	<b>Date</b>	<b>Notes/Changes</b>
A	25/04/08	First release

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